

# TLS203B0 V50

Linear Voltage Post Regulator  
Low Dropout Low Noise 5V 300mA

TLS203B0EJV50

## Data Sheet

Rev. 1.0, 2014-06-30

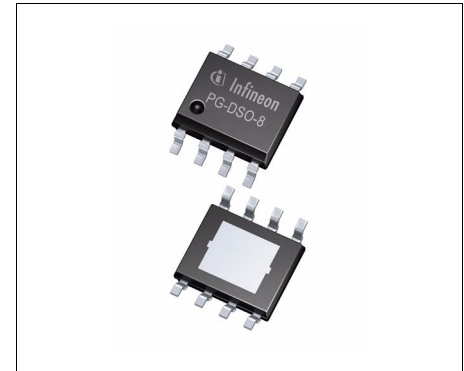
Automotive Power



## 1 Overview

### Features

- Low Noise down to  $42 \mu V_{RMS}$  (BW = 10 Hz to 100 kHz)
- 300 mA Current Capability
- Low Quiescent Current: 30  $\mu A$
- Wide Input Voltage Range up to 20 V
- Internal circuitry working down to 2.3 V
- Low Dropout Voltage: 290 mV
- Very low Shutdown Current: < 1  $\mu A$
- Fixed Output Voltage: 5.0 V
- Stable with  $\geq 3.3 \mu F$  Output Capacitor
- Stable with Aluminium, Tantalum or Ceramic Output Capacitors
- Reverse Polarity Protection
- No Reverse Current
- Overcurrent and Overtemperature Protected
- PG-DSO-8 Exposed Pad Package
- Suitable for use in Automotive Electronics as Post Regulator
- Green Product (RoHS compliant)
- AEC Qualified



**PG-DSO-8 Exposed Pad**

The TLS203B0EJV50 is a micropower, low noise, low dropout voltage 5 V regulator. The device is capable of supplying an output current of 300 mA with a dropout voltage of 290 mV. Designed for use in battery-powered systems, the low quiescent current of 30  $\mu A$  makes it an ideal choice.

One feature of the TLS203B0EJV50 is its low output noise. By adding an external 10 nF bypass capacitor output noise values down to  $42 \mu V_{RMS}$  over a 10 Hz to 100 kHz bandwidth can be reached. The TLS203B0EJV50 voltage regulator is stable with output capacitors as small as 3.3  $\mu F$ . Small ceramic capacitors can be used without the series resistance required by many other linear voltage regulators.

Internal protection circuitry includes reverse battery protection, current limiting and reverse current protection. The TLS203B0EJV50 comes as 5.0 V fixed output voltage variant and is available in a PG-DSO-8 Exposed Pad package.

**Product Overview**

Type	Package	Marking
TLS203B0EJV50	PG-DSO-8 Exposed Pad	203B0V50

## 2 Block Diagram

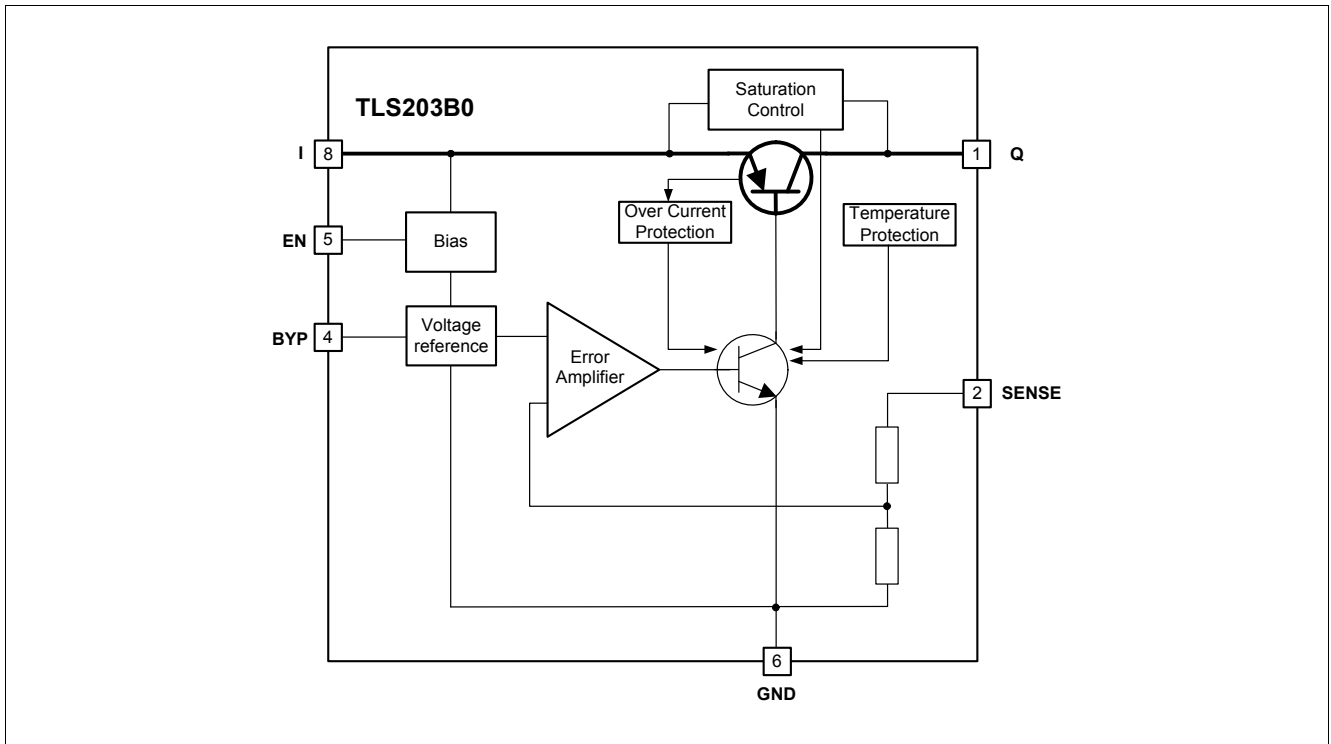


Figure 1 Block Diagram TLS203B0EJV50

### 3 Pin Configuration

#### 3.1 Pin Assignment

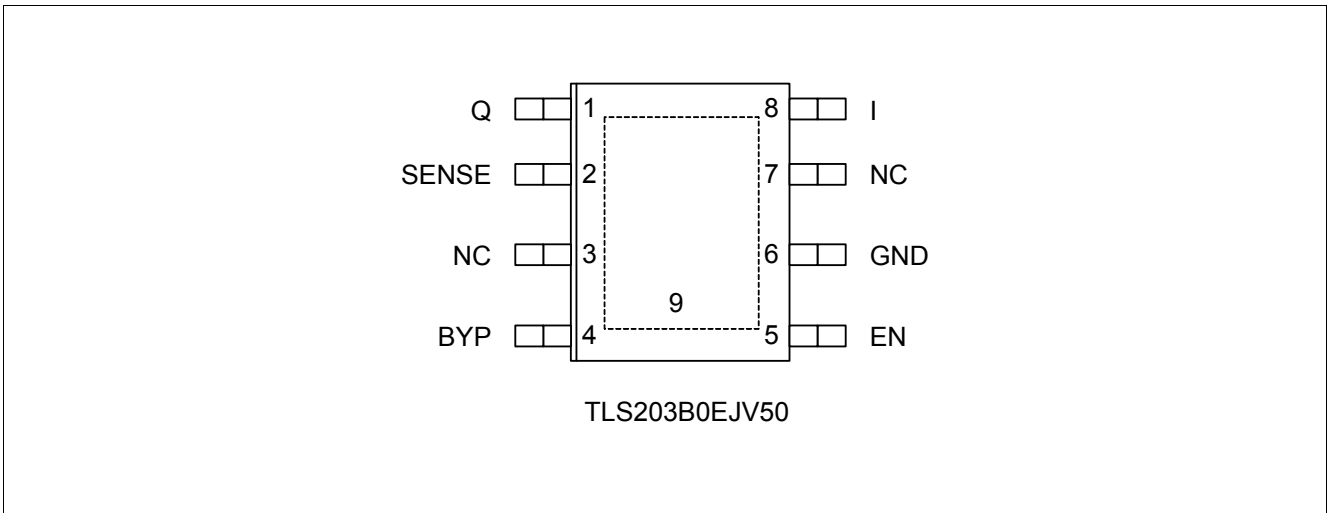


Figure 2 Pin Configuration of TLS203B0EJV50

### 3.2 Pin Definitions and Functions

Pin	Symbol	Function
1	Q	<b>Output.</b> Supplies power to the load. For this pin a minimum output capacitor of 3.3 $\mu\text{F}$ is required to prevent oscillations. Larger output capacitors may be required for applications with large transient loads in order to limit peak voltage transients or when the regulator is applied in conjunction with a bypass capacitor. For more details please refer to <b>“Application Information” on Page 19.</b>
2	SENSE	<b>Output Sense.</b> The SENSE pin is the input to the error amplifier. This allows to achieve an optimized regulation performance in case of small voltage drops $R_p$ that occur between regulator and load. In applications where such drops are relevant they can be eliminated by connecting the SENSE pin directly at the load. In standard configuration the SENSE pin can be directly connected to Q. For further details please refer to the section <b>“Kelvin Sense Connection” on Page 19.</b>
3, 7	NC	<b>No Connect.</b> The NC Pins have no connection to any internal circuitry. Connect either to GND or leave open.
4	BYP	<b>Bypass.</b> The BYP pin is used to bypass the reference of the TLS203B0EJV50 to achieve low noise performance. The BYP-pin is clamped internally to $\pm 0.6\text{ V}$ (i.e. one $V_{BE}$ ). A small capacitor from the output Q to the BYP pin will bypass the reference to lower the output voltage noise <sup>1)</sup> . If not used this pin must be left unconnected.
5	EN	<b>Enable.</b> With the EN pin the TLS203B0EJV50 can be put into a low power shutdown state. The output will be off when the EN is pulled low. The EN pin can be driven either by 3.3 V or 5 V logic or as well by open-collector logic with pull-up resistor. The pull-up resistor is required to supply the pull-up current of the open-collector gate <sup>2)</sup> and the EN pin current <sup>3)</sup> . Please note that if the EN pin is not used it must be connected to $V_I$ . It must not be left floating.
6	GND	<b>Ground.</b>
8	I	<b>Input.</b> The device is supplied by the input pin I. A capacitor at the input pin is required if the device is more than 6 inches away from the main input filter capacitor or if a non-negligible inductance is present at the input I <sup>4)</sup> . The TLS203B0EJV50 is designed to withstand reverse voltages on the input pin I with respect to GND and output Q. In the case of reverse input (e.g. due to a wrongly attached battery) the device will act as if there is a diode in series with its input. In this way there will be no reverse current flowing into the regulator and no reverse voltage will appear at the load. Hence, the device will protect both - the device itself and the load.
9	Tab	<b>Exposed Pad.</b> To ensure proper thermal performance, solder Pin 9 (exposed pad) to the PCB ground and tie directly to Pin 6 (GND).

1) A maximum value of 10 nF can be used for reducing output voltage noise over the bandwidth from 10 Hz to 100 kHz.

2) Normally several microamperes.

3) Typical value is 1  $\mu\text{A}$ .

4) In general the output impedance of a battery rises with frequency, so it is advisable to include a bypass capacitor in battery-powered circuits. Depending on actual conditions an input capacitor in the range of 1 to 10  $\mu\text{F}$  is sufficient.

## 4 General Product Characteristics

### 4.1 Absolute Maximum Ratings

**Table 1 Absolute Maximum Ratings** <sup>1)</sup>

$T_j = -40\text{ °C}$  to  $+150\text{ °C}$ ; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note / Test Condition	Number
		Min.	Typ.	Max.			
<b>Input Voltage</b>							
Voltage	$V_I$	-20	–	20	V	–	P_4.1.1
<b>Output Voltage</b>							
Voltage	$V_Q$	-20	–	20	V	–	P_4.1.2
Input to Output Differential Voltage	$V_I - V_Q$	-20	–	20	V	–	P_4.1.3
<b>Sense Pin</b>							
Voltage	$V_{SENSE}$	-20	–	20	V	–	P_4.1.4
<b>BYP Pin</b>							
Voltage	$V_{BYP}$	-0.6	–	0.6	V		P_4.1.5
<b>Enable Pin</b>							
Voltage	$V_{EN}$	-20	–	20	V	–	P_4.1.6
<b>Temperatures</b>							
Junction Temperature	$T_j$	-40	–	150	°C	–	P_4.1.7
Storage Temperature	$T_{stg}$	-55	–	150	°C	–	P_4.1.8
<b>ESD Susceptibility</b>							
All Pins	$V_{ESD}$	-2	–	2	kV	HBM <sup>2)</sup>	P_4.1.9
All Pins	$V_{ESD}$	-1	–	1	kV	CDM <sup>3)</sup>	P_4.1.10

1) Not subject to production testing, specified by design.

2) ESD susceptibility, HBM according to ANSI/ESDA/JEDEC JS001 (1.5 kΩ, 100 pF)

3) ESD susceptibility, Charged Device Model "CDM" according JEDEC JESD22-C101

#### Notes

1. Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
2. Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

## 4.2 Functional Range

**Table 2 Functional Range**

Parameter	Symbol	Values			Unit	Note / Test Condition	Number
		Min.	Typ.	Max.			
Input Voltage Range	$V_I$	5.5	–	20	V	–	P_4.2.1
Output Capacitor's Requirements for Stability	$C_Q$	3.3	–	–	$\mu\text{F}$	$C_{\text{BYP}} = 0 \text{ nF}^{1)}$	P_4.2.2
Output Capacitor's Requirements for Stability	$C_Q$	6.8	–	–	$\mu\text{F}$	$0 \text{ nF} < C_{\text{BYP}} \leq 10 \text{ nF}^{1)}$	P_4.2.3
ESR	$ESR$	$\leq 2)$	–	3	$\Omega$	$\leq 1)$	P_4.2.4
Operating Junction Temperature	$T_j$	-40	–	125	$^{\circ}\text{C}$	–	P_4.2.5

1) for further details see corresponding graph.

2)  $C_{\text{BYP}} = 0 \text{ nF}$ ,  $C_Q \geq 3.3 \mu\text{F}$ ; please note that for cases where a bypass capacitor at BYP is used – depending on the actual applied capacitance of  $C_Q$  and  $C_{\text{BYP}}$  a minimum requirement for ESR of  $C_Q$  may apply.

*Note: Within the functional or operating range, the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the Electrical Characteristics table.*

## 4.3 Thermal Resistance

*Note: This thermal data was generated in accordance with JEDEC JESD51 standards. For more information, go to [www.jedec.org](http://www.jedec.org).*

**Table 3 Thermal Resistance <sup>1)</sup>**

Parameter	Symbol	Values			Unit	Note / Test Condition	Number
		Min.	Typ.	Max.			
<b>TLS203B0EJ (PG-DSO-8 Exposed Pad)</b>							
Junction to Case	$R_{\text{thJC}}$	–	7.0	–	K/W	–	P_4.3.1
Junction to Ambient	$R_{\text{thJA}}$	–	39	–	K/W	$\leq 2)$	P_4.3.2
Junction to Ambient	$R_{\text{thJA}}$	–	155	–	K/W	Footprint only <sup>3)</sup>	P_4.3.3
Junction to Ambient	$R_{\text{thJA}}$	–	66	–	K/W	300 mm <sup>2</sup> heatsink area on PCB <sup>3)</sup>	P_4.3.4
Junction to Ambient	$R_{\text{thJA}}$	–	52	–	K/W	600 mm <sup>2</sup> heatsink area on PCB <sup>3)</sup>	P_4.3.5

1) Not subject to production test, specified by design.

2) Specified  $R_{\text{thJA}}$  value is according to Jedec JESD51-2,-5,-7 at natural convection on FR4 2s2p board; The Product (Chip+Package) was simulated on a 76.2 x 114.3 x 1.5 mm board with 2 inner copper layers (2 x 70  $\mu\text{m}$  Cu, 2 x 35  $\mu\text{m}$  Cu). Where applicable a thermal via array under the exposed pad contacted the first inner copper layer.

3) Specified  $R_{\text{thJA}}$  value is according to JEDEC JESD 51-3 at natural convection on FR4 1s0p board; The Product (Chip+Package) was simulated on a 76.2 x 114.3 x 1.5 mm<sup>3</sup> board with 1 copper layer (1 x 70  $\mu\text{m}$  Cu).



## 5 Electrical Characteristics

**Table 4 Electrical Characteristics**

-40 °C <  $T_j$  < 125 °C; all voltages with respect to ground; positive current defined flowing out of pin; unless otherwise specified.

Parameter	Symbol	Values			Unit	Note / Test Condition	Number
		Min.	Typ.	Max.			
<b>Minimum Operating Voltage</b> <sup>1)</sup>							
Minimum Operating Voltage	$V_{I,min}$	–	1.8	2.3	V	$I_Q = 300 \text{ mA}$	P_5.0.1
<b>Output Voltage</b> <sup>2)</sup>							
Output Voltage	$V_Q$	4.875	5.00	5.125	V	$1 \text{ mA} < I_Q < 300 \text{ mA}$ ; $6 \text{ V} < V_I < 20 \text{ V}$	P_5.0.2
<b>Line Regulation</b>							
Line Regulation	$\Delta V_Q$	–	1	25	mV	$\Delta V_I = 5.5 \text{ V to } 20 \text{ V}$ ; $I_Q = 1 \text{ mA}$	P_5.0.3
<b>Load Regulation</b>							
Load Regulation	$\Delta V_Q$	–	8	22	mV	$T_J = 25 \text{ °C}$ ; $V_I = 6.0 \text{ V}$ ; $\Delta I_Q = 1 - 300 \text{ mA}$	P_5.0.4
Load Regulation	$\Delta V_Q$	–	–	43	mV	$V_I = 6.0 \text{ V}$ ; $\Delta I_Q = 1 - 300 \text{ mA}$	P_5.0.5
<b>Dropout Voltage</b> <sup>3)</sup>							
Dropout Voltage	$V_{DR}$	–	130	190	mV	$I_Q = 10 \text{ mA}$ ; $V_I = V_{Q,nom}$ ; $T_J = 25 \text{ °C}$	P_5.0.6
Dropout Voltage	$V_{DR}$	–	–	250	mV	$I_Q = 10 \text{ mA}$ ; $V_I = V_{Q,nom}$	P_5.0.7
Dropout Voltage	$V_{DR}$	–	170	220	mV	$I_Q = 50 \text{ mA}$ ; $V_I = V_{Q,nom}$ ; $T_J = 25 \text{ °C}$	P_5.0.8
Dropout Voltage	$V_{DR}$	–	–	320	mV	$I_Q = 50 \text{ mA}$ ; $V_I = V_{Q,nom}$	P_5.0.9
Dropout Voltage	$V_{DR}$	–	200	240	mV	$I_Q = 100 \text{ mA}$ ; $V_I = V_{Q,nom}$ ; $T_J = 25 \text{ °C}$	P_5.0.10
Dropout Voltage	$V_{DR}$	–	–	340	mV	$I_Q = 100 \text{ mA}$ ; $V_I = V_{Q,nom}$	P_5.0.11
Dropout Voltage	$V_{DR}$	–	290	320	mV	$I_Q = 300 \text{ mA}$ ; $V_I = V_{Q,nom}$ ; $T_J = 25 \text{ °C}$	P_5.0.12
Dropout Voltage	$V_{DR}$	–	–	410	mV	$I_Q = 300 \text{ mA}$ ; $V_I = V_{Q,nom}$	P_5.0.13
<b>Quiescent Current</b>							
Quiescent Current (Active-Mode, EN-pin high)	$I_q$	–	30	60	μA	$V_I = V_{Q,nom}$ ; $I_Q = 0 \text{ mA}$	P_5.0.14
Quiescent Current (Off-Mode, EN-pin low)	$I_q$	–	0.1	1	μA	$V_I = 6 \text{ V}$ ; $V_{EN} = 0 \text{ V}$ ; $T_J = 25 \text{ °C}$	P_5.0.15
<b>GND Pin Current</b> <sup>4)</sup>							
GND Pin Current	$I_{GND}$	–	50	100	μA	$V_I = V_{Q,nom}$ ; $I_Q = 1 \text{ mA}$	P_5.0.16
GND Pin Current	$I_{GND}$	–	300	850	μA	$V_I = V_{Q,nom}$ ; $I_Q = 50 \text{ mA}$	P_5.0.17

## Electrical Characteristics

**Table 4 Electrical Characteristics (cont'd)**

-40 °C < T<sub>j</sub> < 125 °C; all voltages with respect to ground; positive current defined flowing out of pin; unless otherwise specified.

Parameter	Symbol	Values			Unit	Note / Test Condition	Number
		Min.	Typ.	Max.			
GND Pin Current	I <sub>GND</sub>	–	0.7	2.2	mA	V <sub>I</sub> = V <sub>Q,nom</sub> ; I <sub>Q</sub> = 100 mA	P_5.0.18
GND Pin Current	I <sub>GND</sub>	–	4	12	mA	V <sub>I</sub> = V <sub>Q,nom</sub> ; I <sub>Q</sub> = 300 mA	P_5.0.19
<b>Enable</b>							
Enable Threshold High	V <sub>th,EN</sub>	–	0.8	2.0	V	V <sub>Q</sub> = Off to On	P_5.0.20
Enable Threshold Low	V <sub>tl,EN</sub>	0.25	0.65	–	V	V <sub>Q</sub> = On to Off	P_5.0.21
EN Pin Current <sup>5)</sup>	I <sub>EN</sub>	–	0.01	–	μA	V <sub>EN</sub> = 0 V ; T <sub>J</sub> = 25 °C	P_5.0.22
EN Pin Current	I <sub>EN</sub>	–	1	–	μA	V <sub>EN</sub> = 20V ; T <sub>J</sub> = 25 °C	P_5.0.23
<b>Output Voltage Noise <sup>6)</sup></b>							
Output Voltage Noise	e <sub>no</sub>	–	55	–	μV <sub>RMS</sub>	C <sub>Q</sub> = 10 μF ; C <sub>BYP</sub> = 10 nF ; I <sub>Q</sub> = 300 mA ; BW = 10 Hz to 100 kHz	P_5.0.24
Output Voltage Noise	e <sub>no</sub>	–	44	–	μV <sub>RMS</sub>	C <sub>Q</sub> = 10 μF +250mΩ resistor in series; C <sub>BYP</sub> = 10 nF ; I <sub>Q</sub> = 300 mA ; BW = 10 Hz to 100 kHz	P_5.0.25
Output Voltage Noise	e <sub>no</sub>	–	42	–	μV <sub>RMS</sub>	C <sub>Q</sub> = 22 μF C <sub>BYP</sub> = 10 nF ; I <sub>Q</sub> = 300 mA ; BW = 10 Hz to 100 kHz	P_5.0.26
Output Voltage Noise	e <sub>no</sub>	–	42	–	μV <sub>RMS</sub>	C <sub>Q</sub> = 22 μF +250mΩ resistor in series; C <sub>BYP</sub> = 10 nF ; I <sub>Q</sub> = 300 mA ; BW = 10 Hz to 100 kHz	P_5.0.27
<b>Power Supply Ripple Rejection <sup>6)</sup></b>							
Power Supply Ripple Rejection	PSRR	–	65	–	dB	V <sub>I</sub> - V <sub>Q</sub> = 1.5 V (avg) ; V <sub>RIPPLE</sub> = 0.5 Vpp ; f <sub>r</sub> = 120 Hz ; I <sub>Q</sub> = 300 mA	P_5.0.28
<b>Output Current Limitation</b>							
Output Current Limit	I <sub>Q,limit</sub>	320	–	–	mA	V <sub>I</sub> = 7 V ; V <sub>Q</sub> = 0 V	P_5.0.29
Output Current Limit	I <sub>Q,limit</sub>	320	–	–	mA	V <sub>I</sub> = V <sub>Q,nom</sub> + 1 V ΔV <sub>Q</sub> = -0.1 V	P_5.0.30
<b>Input Reverse Leakage Current</b>							
Input Reverse Leakage	I <sub>leak,rev</sub>	–	–	1	mA	V <sub>I</sub> = -20 V ; V <sub>Q</sub> = 0 V	P_5.0.31
<b>Reverse Output Current <sup>7)</sup></b>							
Fixed Voltage Versions	I <sub>Reverse</sub>	–	10	20	μA	V <sub>Q</sub> = V <sub>Q,nom</sub> ; V <sub>I</sub> < V <sub>Q,nom</sub> ; T <sub>J</sub> = 25 °C	P_5.0.32

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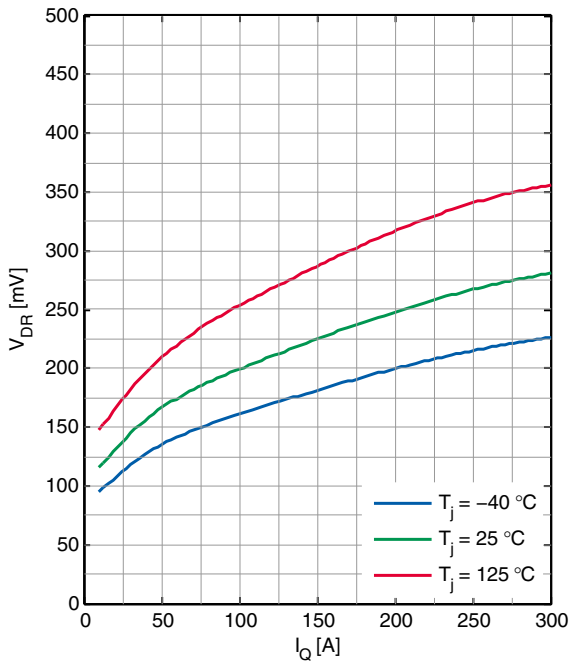
**Electrical Characteristics**

- 1) This parameter defines the minimum input voltage for which the device is powered up and provides the maximum nominal output current of 300 mA. Under this minimum input voltage condition the TLS203B0EJV50 starts to be in tracking mode and the output voltage will typically be in the range of around 1 V while providing the 300 mA.
- 2) The operation conditions are limited by the maximum junction temperature. The regulated output voltage specification will only apply for conditions where the limit of the maximum junction temperature is fulfilled. It will therefore not apply for all possible combinations of input voltage and output current. When operating at maximum input voltage, the output current must be limited for thermal reasons. The same holds true when operating at maximum output current where the input voltage range must be limited for thermal reasons.
- 3) The dropout voltage is the minimum input to output voltage differential needed to maintain regulation at a specified output current. In dropout, the output voltage will be equal to  $V_I - V_{DR}$
- 4) GND-pin current is tested with  $V_I = V_{Q,nom}$  and a current source load. This means that this parameter is tested while being in the dropout region. The GND pin current will in most cases decrease slightly at higher input voltages - please also refer to the corresponding typical performance graphs.
- 5) The EN pin current flows into EN pin.
- 6) Not subject to production test, specified by design.
- 7) Reverse output current is tested with the I pin grounded and the Q pin forced to the rated output voltage. This current flows into the Q pin and out of the GND pin.

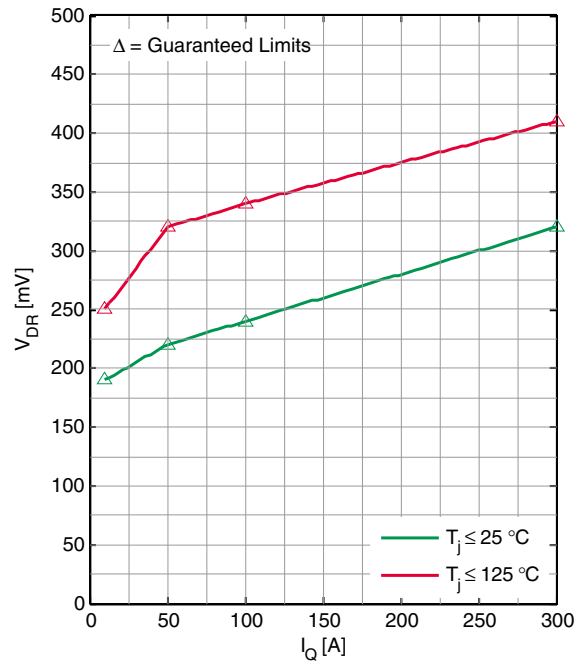
*Note: The listed characteristics are ensured over the operating range of the integrated circuit. Typical characteristics specified mean values expected over the production spread. If not otherwise specified, typical characteristics apply at  $T_A = 25^\circ\text{C}$  and the given supply voltage.*

### 5.1 Typical Performance Characteristics

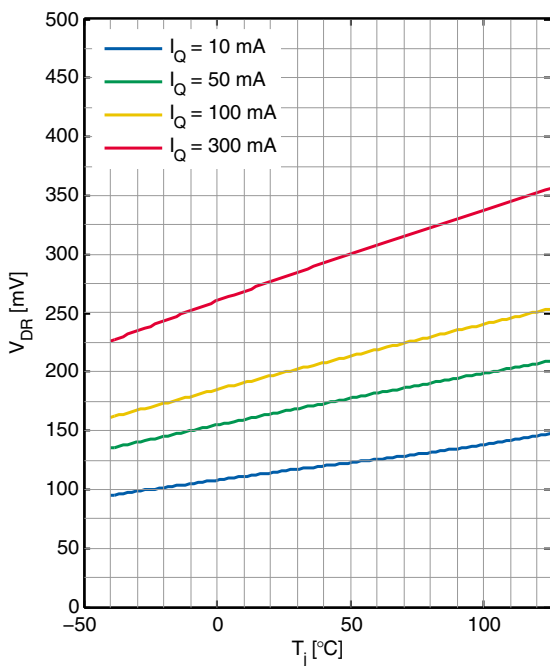
Dropout Voltage  $V_{DR}$  versus Output Current  $I_Q$



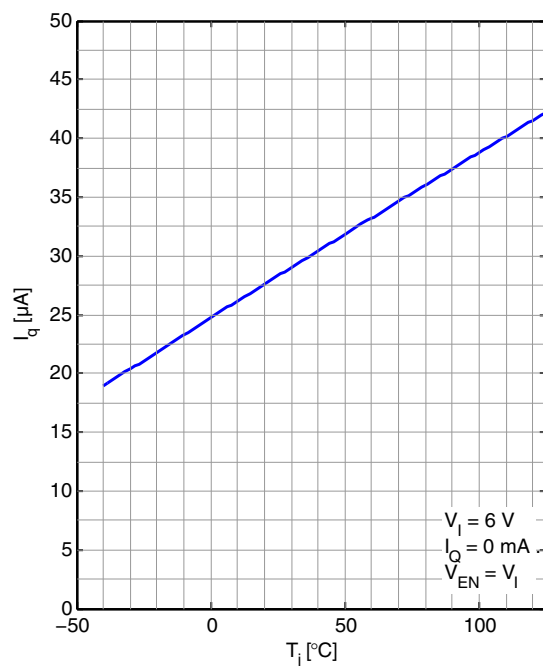
Guaranteed Dropout Voltage  $V_{DR}$  versus Output Current  $I_Q$



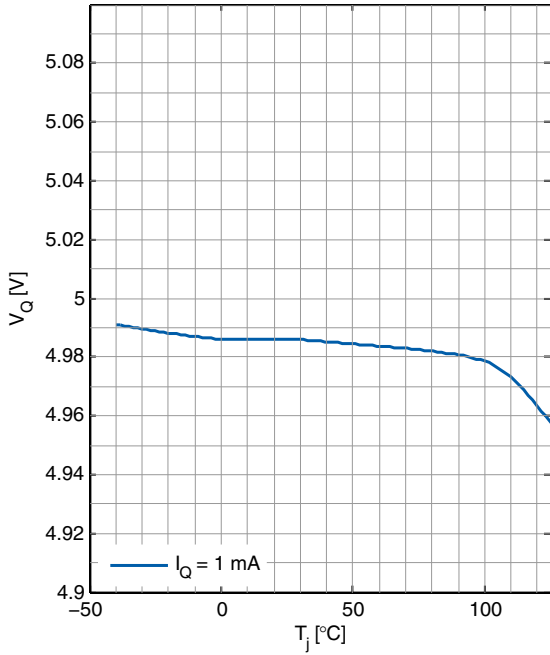
Dropout Voltage  $V_{DR}$  versus Junction Temperature  $T_j$



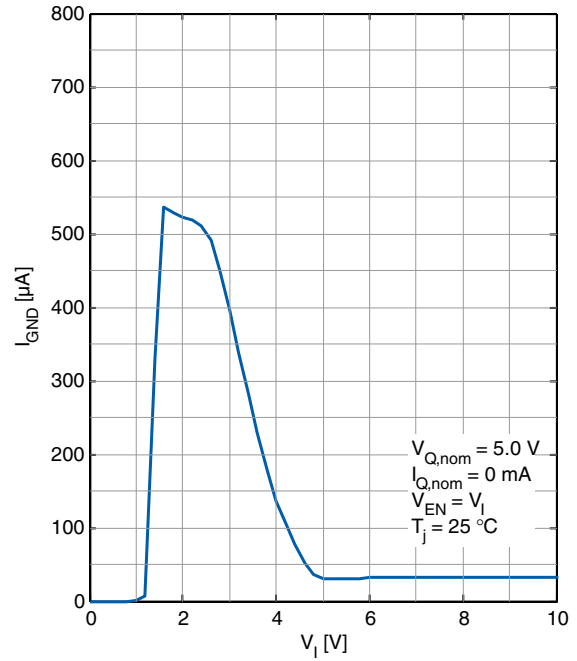
Quiescent Current versus Junction Temperature  $T_j$



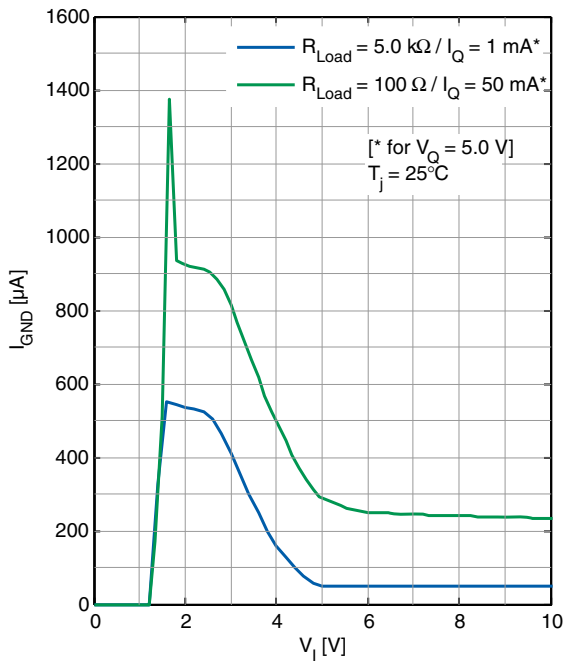
**Output Voltage  $V_Q$  versus Junction Temperature  $T_J$**



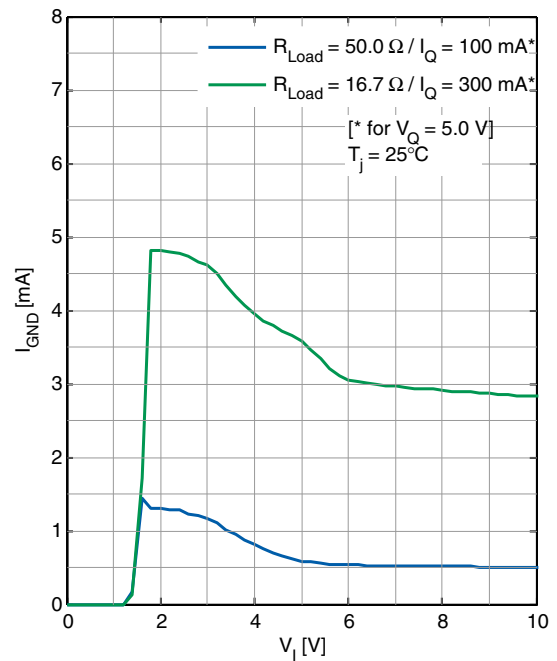
**Quiescent Current  $I_Q$  versus Input Voltage  $V_I$**



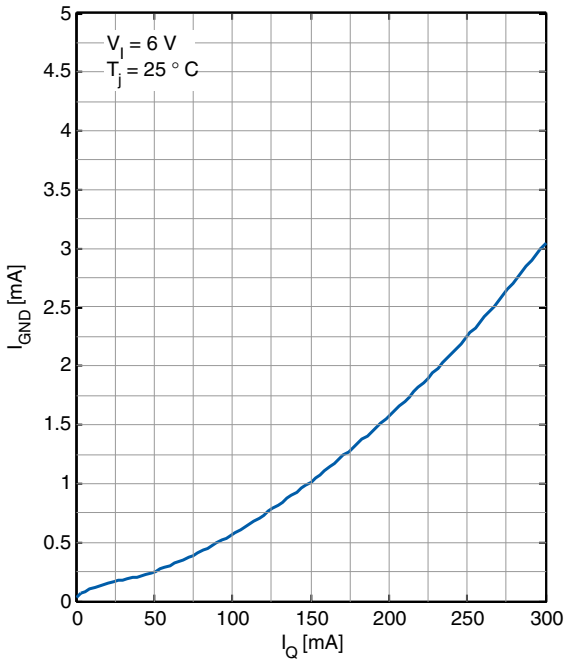
**GND Pin Current  $I_{GND}$  versus Input Voltage  $V_I$**



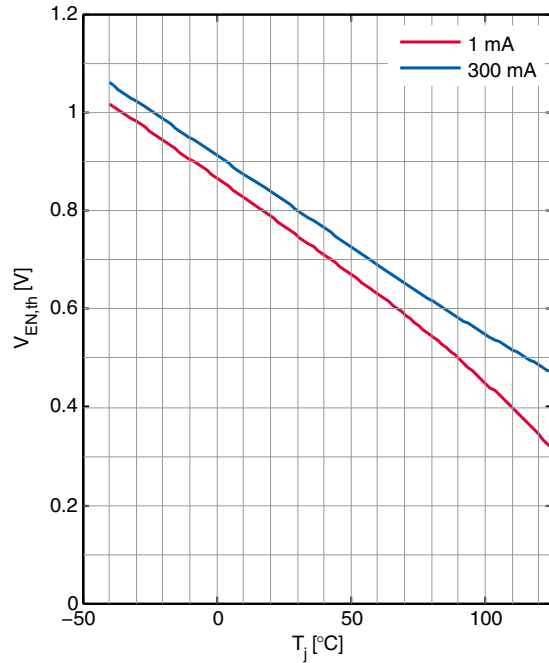
**GND Pin Current  $I_{GND}$  versus Input Voltage  $V_I$**



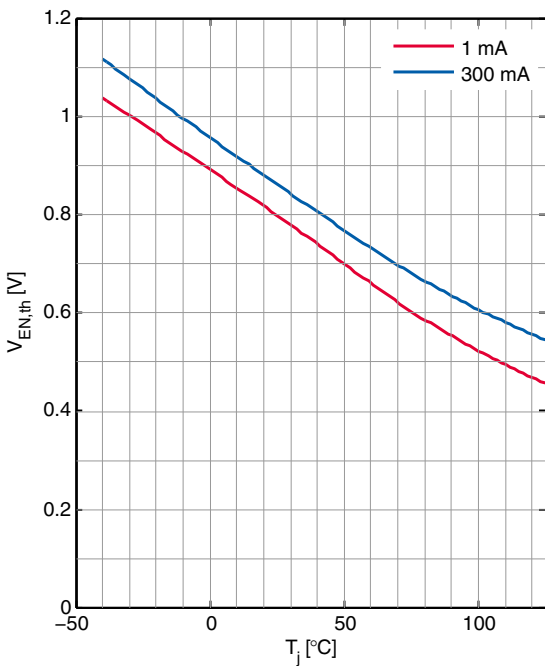
**GND Pin Current  $I_{GND}$  versus Output Current  $I_Q$**



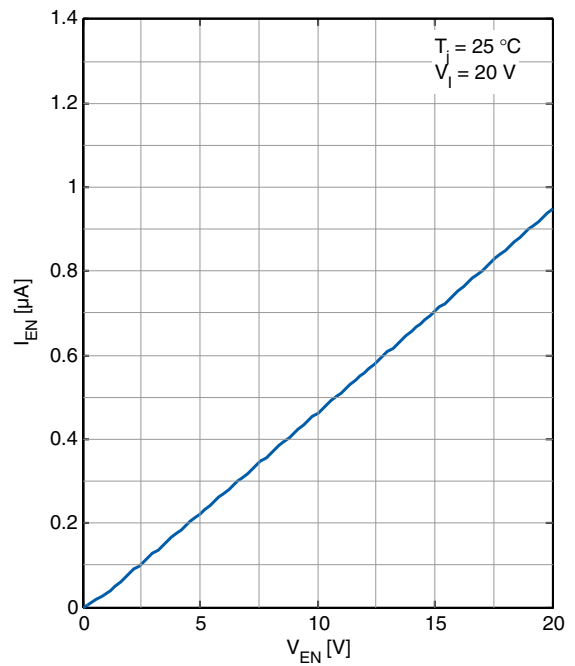
**EN Pin Threshold (On-to-Off) versus Junction Temperature  $T_j$**



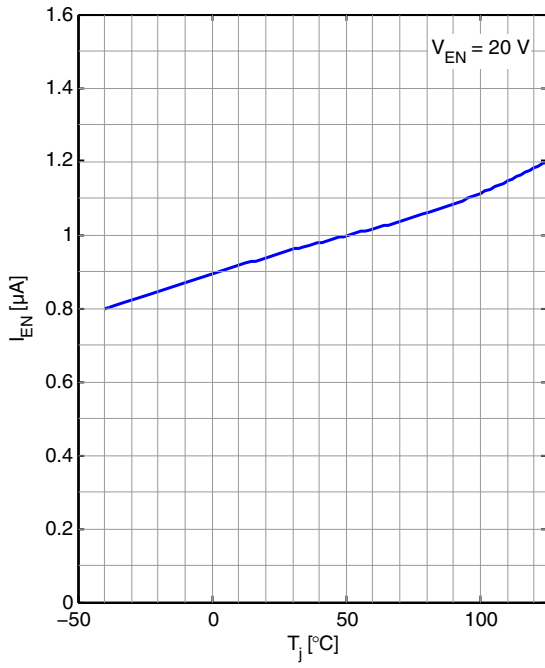
**EN Pin Threshold (Off-to-On) versus Junction Temperature  $T_j$**



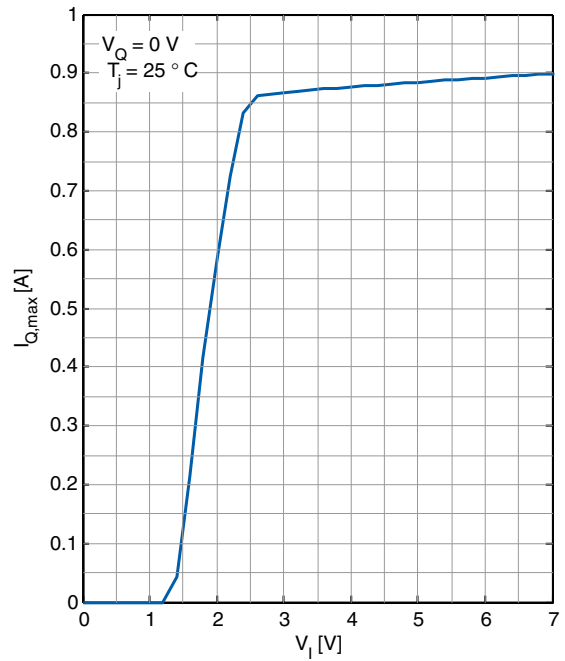
**EN Pin Input Current versus EN Pin Voltage  $V_{EN}$**



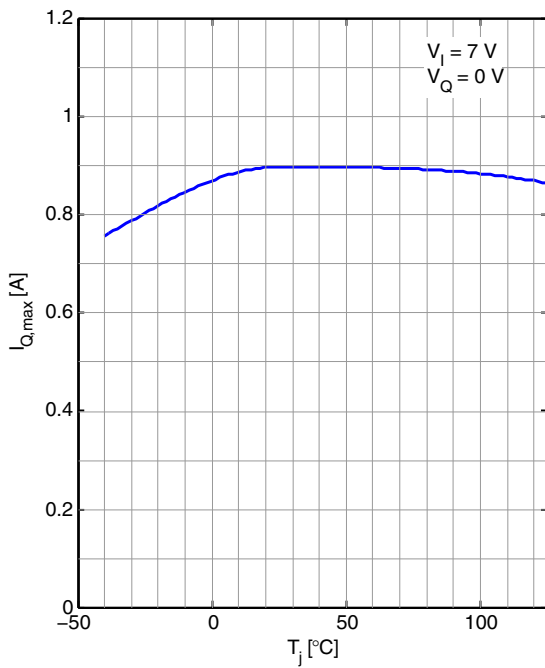
**EN Pin Current versus Junction Temperature  $T_j$**



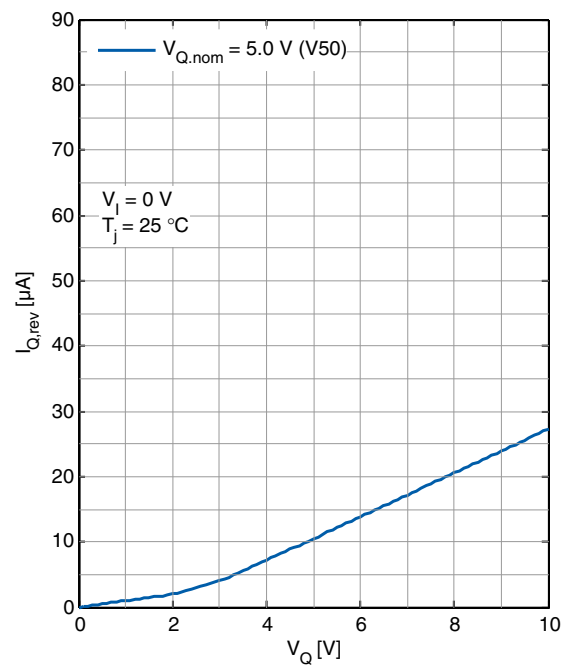
**Current Limit versus Input Voltage  $V_I$**



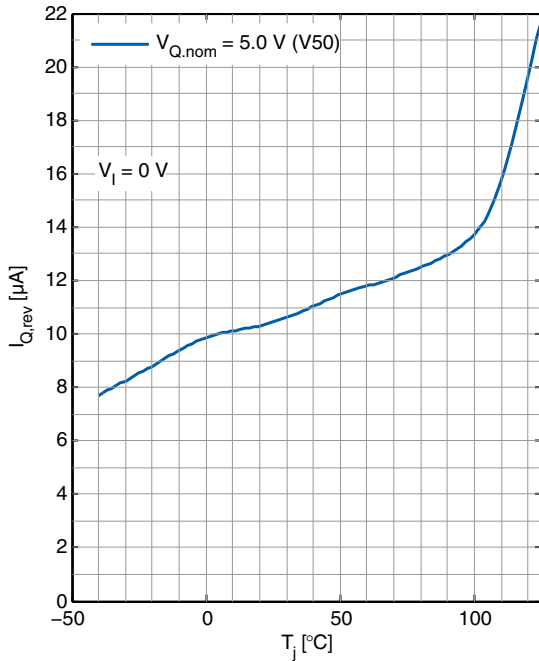
**Current Limit versus Junction Temperature  $T_j$**



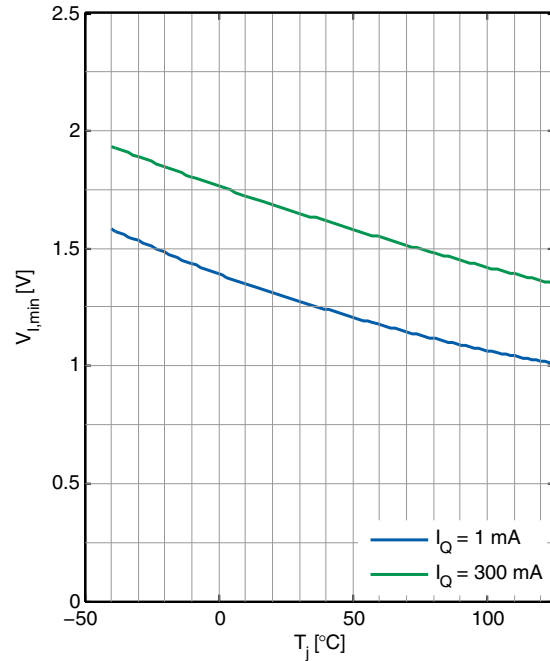
**Reverse Output Current versus Output Voltage  $V_Q$**



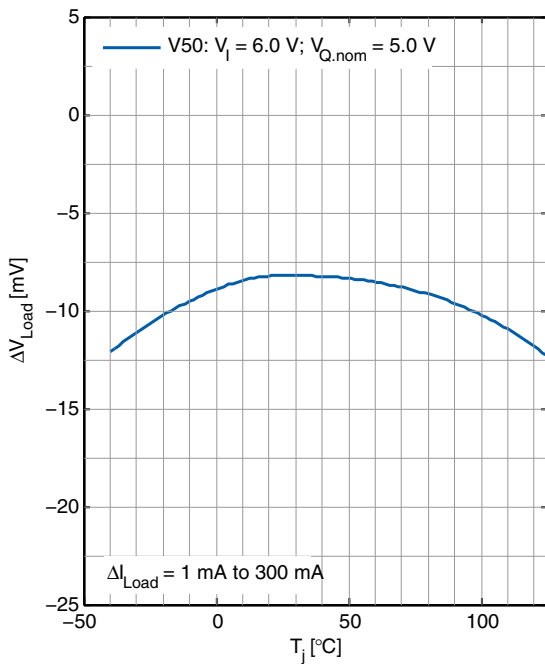
Reverse Output Current versus Junction Temperature  $T_J$



Minimum Input Voltage <sup>1)</sup> versus Junction Temperature  $T_J$



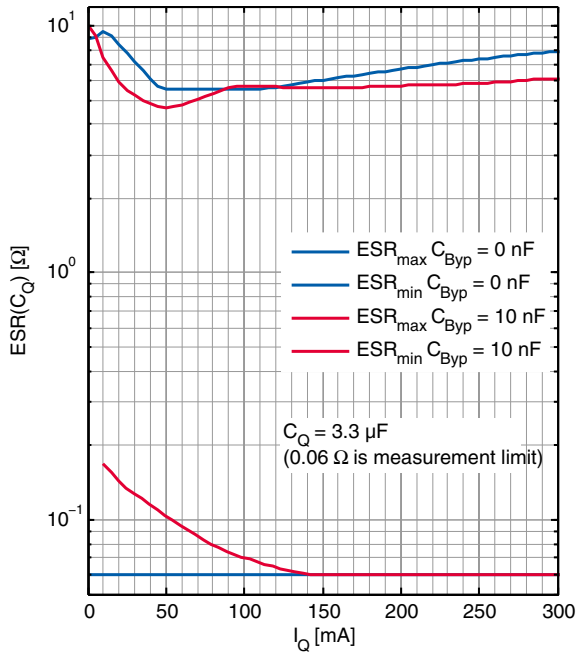
Load Regulation versus Junction Temperature  $T_J$



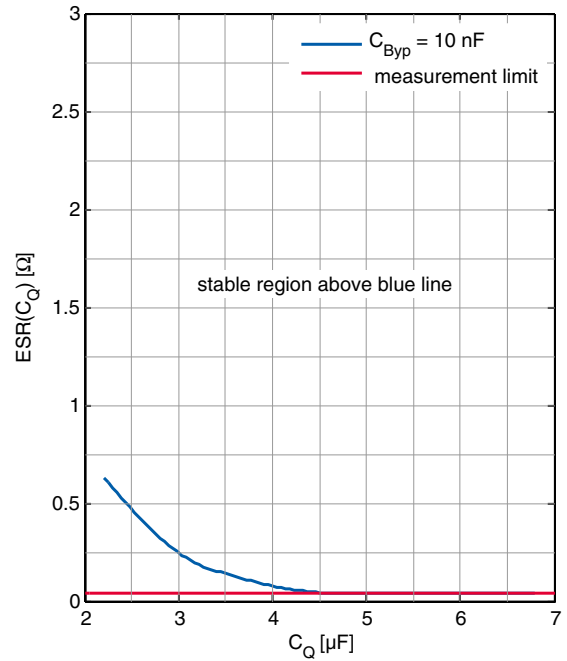
1)  $V_{I,min}$  is referred here as the minimum input voltage for which the requested current is provided and  $V_Q$  reaches 1 V.



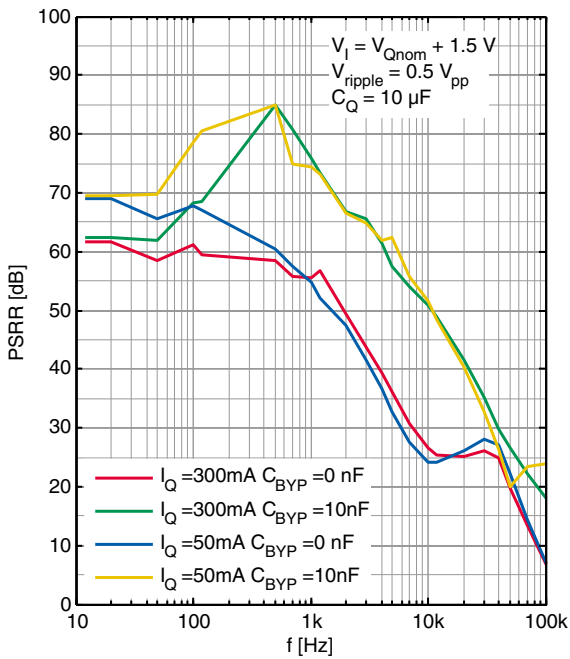
**ESR Stability versus Output Current  $I_Q$  (for  $C_Q = 3.3 \mu\text{F}$ )**



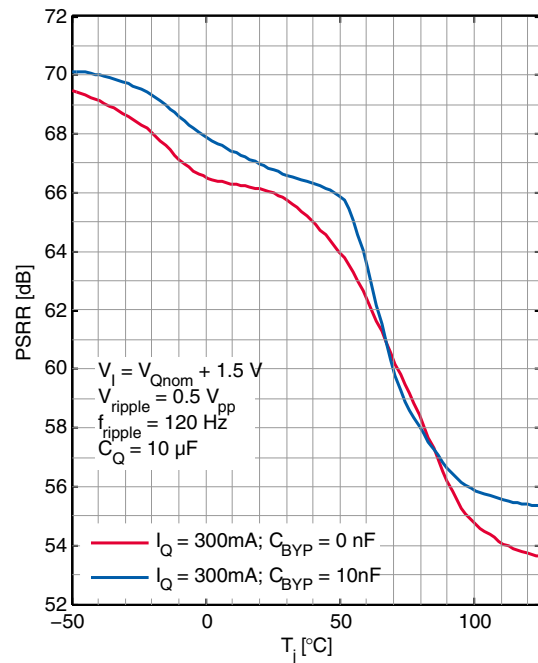
**ESR( $C_Q$ ) with  $C_{BYP} = 10 \text{ nF}$  versus Output Capacitance  $C_Q$**



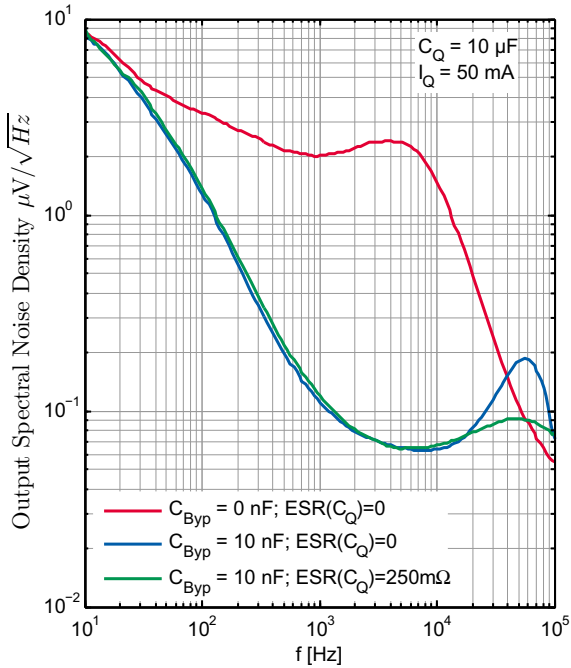
**Input Ripple Rejection PSRR versus Frequency  $f$**



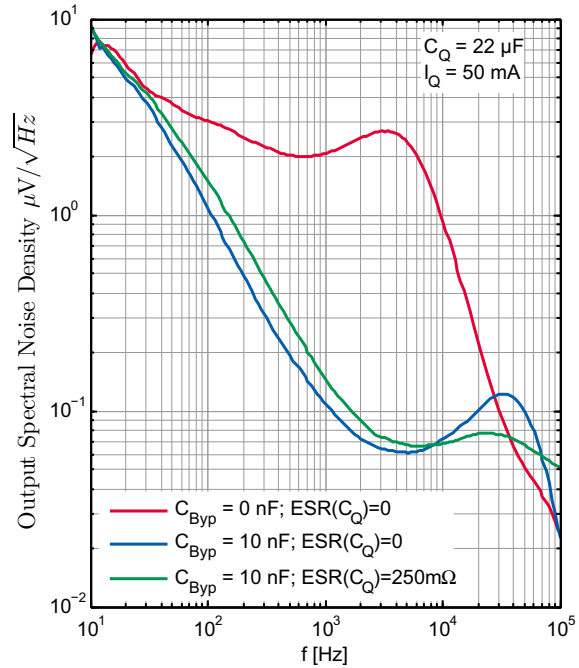
**Input Ripple Rejection PSRR versus Junction Temperature  $T_J$**



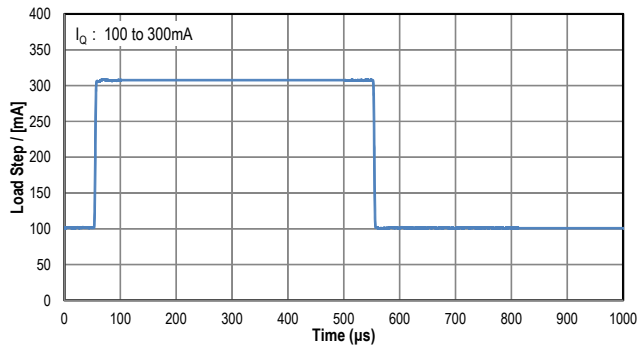
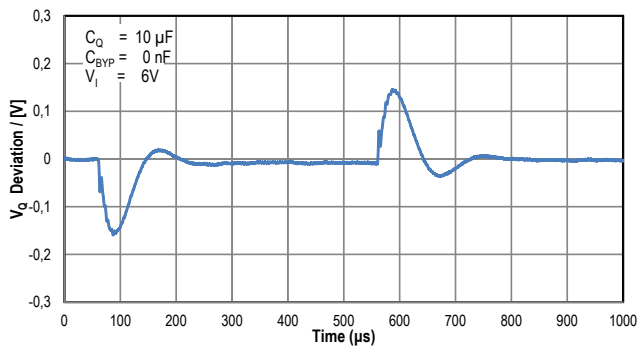
**Output Noise Spectral Density versus Frequency  $f$  ( $C_Q = 10 \mu\text{F}$ ,  $I_Q = 50 \text{ mA}$ )**



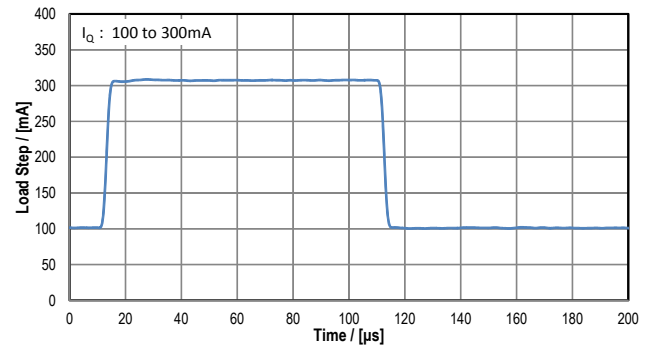
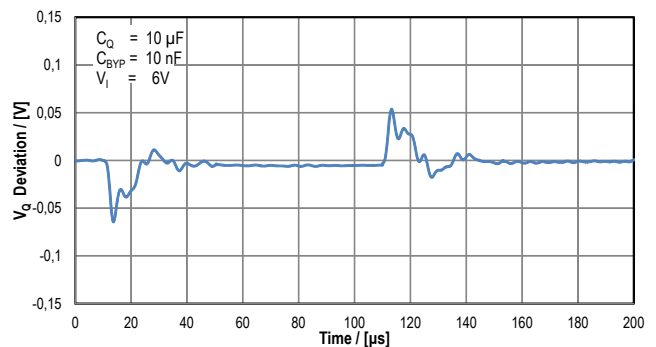
**Output Noise Spectral Density versus Frequency  $f$  ( $C_Q = 22 \mu\text{F}$ ,  $I_Q = 50 \text{ mA}$ )**



**Transient Response  $C_{BYP} = 0 \text{ nF}$**



**Transient Response  $C_{BYP} = 10 \text{ nF}$**



## 6 Application Information

Note: The following information is given as a hint for the implementation of the device only and shall not be regarded as a description or warranty of a certain functionality, condition or quality of the device.

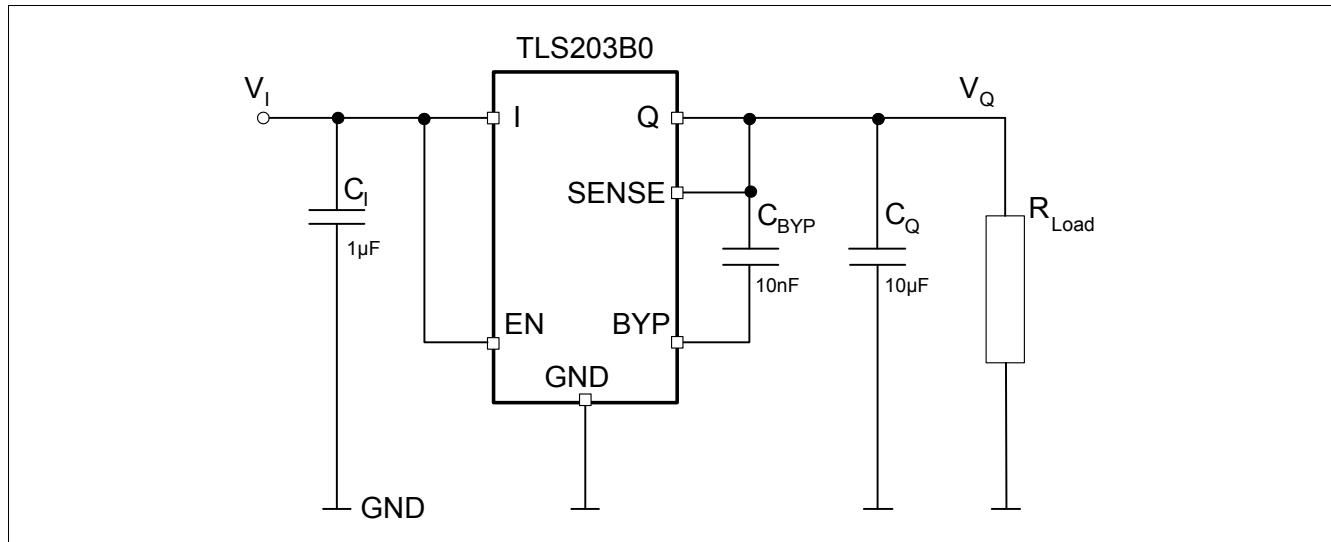


Figure 3 Typical Application Circuit TLS203B0EJV50

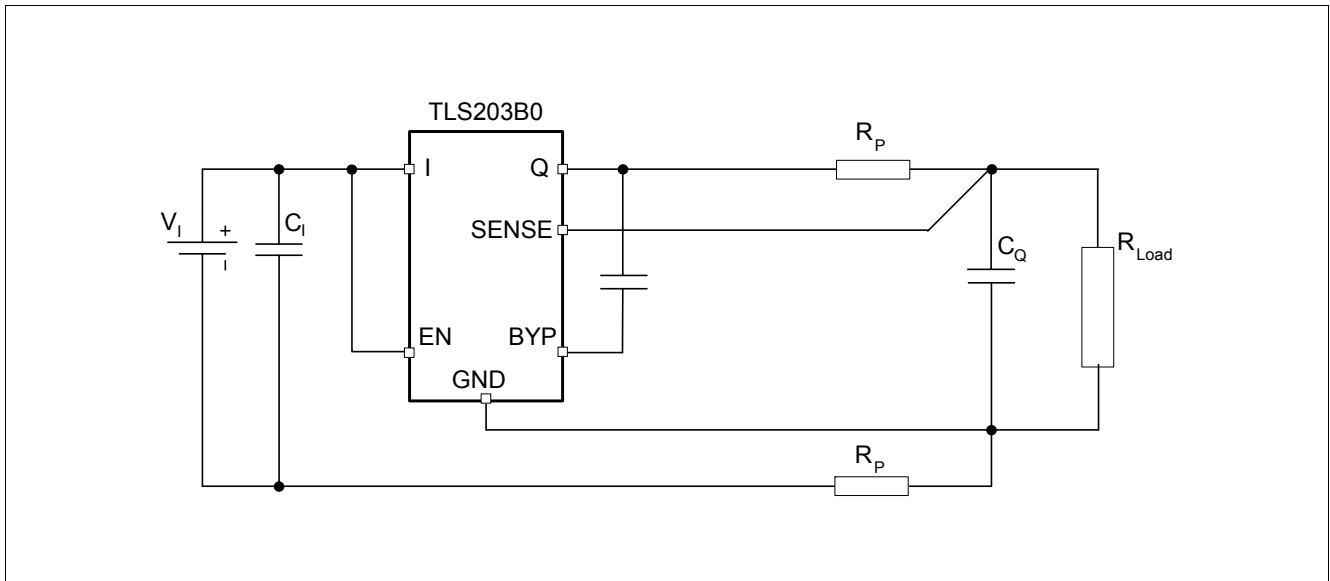
Note: This is a very simplified example of an application circuit. The function must be verified in the real application.<sup>1)2)</sup>

The TLS203B0EJV50 is a 300 mA low dropout regulator with very low quiescent current and Enable-functionality. The device is capable of supplying 300 mA at a dropout voltage of 290 mV. Output voltage noise numbers down to  $42 \mu V_{RMS}$  can be achieved over a 10 Hz to 100 kHz bandwidth with the addition of a 10 nF reference bypass capacitor. The usage of a reference bypass capacitor will additionally improve transient response of the regulator, lowering the settling time for transient load conditions. The device has a low operating quiescent current of typical 30  $\mu A$  that drops to less than 1  $\mu A$  in shutdown (EN-pin pulled to low level). The device also incorporates several protection features which makes it ideal for battery-powered systems. It is protected against both reverse input and reverse output voltages.

### 6.1 Kelvin Sense Connection

The SENSE pin of the TLS203B0EJV50 is the input to the error amplifier. An optimum regulation will be obtained at the point where the SENSE pin is connected to the output pin Q of the regulator. In critical applications however small voltage drops may be caused by the resistance  $R_p$  of the PC-traces and thus may lower the resulting voltage at the load. This effect may be eliminated by connecting the SENSE pin to the output as close as possible at the load (see [Figure 4](#)). Please note that the voltage drop across the external PC trace will add up to the dropout voltage of the regulator.

- 1) Please note that in case a non-negligible inductance at the input pin I is present, e.g. due to long cables, traces, parasitics, etc, a bigger input capacitor  $C_1$  may be required to filter its influence. As a rule of thumb if the I pin is more than six inches away from the main input filter capacitor an input capacitor value of  $C_1 = 10 \mu F$  is recommended.
- 2) For specific needs a small optional resistor may be placed in series to very low ESR output capacitors  $C_Q$  for enhanced noise performance (for details please see ["Bypass Capacitance and Low Noise Performance"](#) on [Page 20](#)).



**Figure 4 Kelvin Sense Connection**

## 6.2 Bypass Capacitance and Low Noise Performance

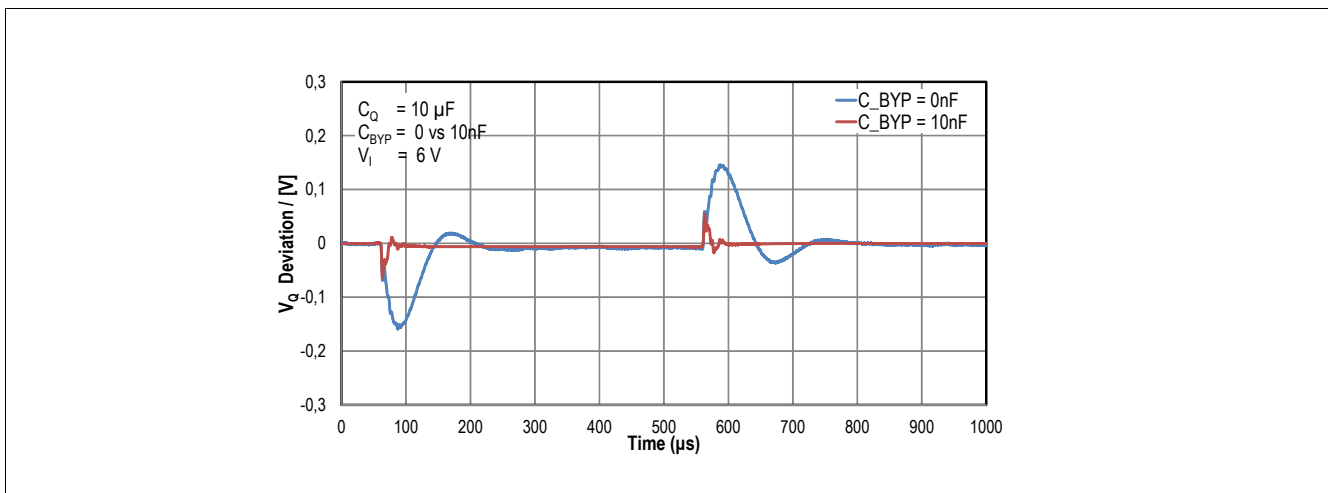
The TLS203B0EJV50 regulator may be used in combination with a bypass capacitor connecting the output pin Q to the BYP pin in order to minimize output voltage noise<sup>1)</sup>. This capacitor will bypass the reference of the regulator, providing a low frequency noise pole. The noise pole provided by such a bypass capacitor will lower the output voltage noise in the considered bandwidth. Actual numbers of the output voltage noise of the TLS203B0EJV50 will - next to the bypass capacitor itself - be dependent on the capacitance of the applied output capacitor  $C_Q$  and its ESR: In case of applying a bypass capacitor of 10 nF in combination with a (low ESR) ceramic  $C_Q$  of 10  $\mu\text{F}$  output voltage noise numbers will be in the range of typical  $55 \mu\text{V}_{\text{RMS}}$ . This output noise level can be reduced to typical  $44 \mu\text{V}_{\text{RMS}}$  under the same conditions by adding a small resistor of  $\sim 250 \text{ m}\Omega$  in series to the 10  $\mu\text{F}$  ceramic output capacitor acting as additional ESR. A reduction of the output voltage noise can also be achieved by increasing capacitance of the output capacitor. For  $C_Q = 22 \mu\text{F}$  (ceramic low ESR) the output voltage noise will be typically around  $42 \mu\text{V}_{\text{RMS}}$ . For output capacitor values of 22  $\mu\text{F}$  or bigger adding resistance in series to  $C_Q$  does not further lower output noise numbers significantly anymore. For further details please also see “[Output Voltage Noise](#)” on [Page 10](#)., of the Electrical Characteristics. Please note that next to reducing the output voltage noise level the usage of a bypass capacitor has the additional benefit of improving transient response which will be also explained in the next chapter. However one needs to take into consideration that on the other hand the regulator start-up time is proportional to the size of the bypass capacitor and slows down to values around 15 ms when using a 10 nF bypass capacitor in combination with a 10  $\mu\text{F}$   $C_Q$  output capacitor.

## 6.3 Output Capacitance and Transient Response

The TLS203B0EJV50 is designed to be stable with a wide range of output capacitors. The ESR of the output capacitor is an essential parameter with regard to stability, most notably with small capacitors. A minimum output capacitor of 3.3  $\mu\text{F}$  with an ESR of 3  $\Omega$  or less is recommended to prevent oscillations. Like in general for LDO's the output transient response of the TLS203B0EJV50 will be a function of the output capacitance. Larger values of output capacitance decrease peak deviations and thus improve transient response for larger load current changes. Bypass capacitors, used to decouple individual components powered by the TLS203B0EJV50 will increase the effective output capacitor value. Please note that with the usage of bypass capacitors for low noise operation either larger values of output capacitors may be needed or a minimum ESR requirement of  $C_Q$  may have to be considered (see also typical performance graph “[ESR\(CQ\) with CBYP = 10 nF versus Output](#)”

1) a good quality low leakage capacitor is recommended.

**Capacitance  $C_Q$**  on Page 17 as example). In conjunction with the usage of a 10 nF bypass capacitor an output capacitor  $C_Q \geq 6.8 \mu\text{F}$  is recommended. The benefit of a bypass capacitor to the transient response performance is impressive and illustrated as one example in **Figure 5** where the transient response of the TLS203B0EJV33 to one and the same load step from 100 mA to 300 mA is shown with and without a 10 nF bypass capacitor: for the given configuration of  $C_Q = 10 \mu\text{F}$  with no bypass capacitor the load step will settle in the range of less than 200  $\mu\text{s}$  while for  $C_Q = 10 \mu\text{F}$  in conjunction with a 10 nF bypass capacitor the same load step will settle in the range of 20  $\mu\text{s}$ . Due to the shorter reaction time of the regulator by adding the bypass capacitor not only the settling time improves but also output voltage deviations due to load steps are sharply reduced.



**Figure 5 Influence of  $C_{BYP}$ : example of transient response to one and the same load step with and without  $C_{BYP}$  of 10 nF ( $I_Q$ : 100 mA to 300 mA)**

## 6.4 Protection Features

The TLS203B0EJV50 regulators incorporate several protection features which make them ideal for use in battery-powered circuits. In addition to normal protection features associated with monolithic regulators like current limiting and thermal limiting the device is protected against reverse input voltage, reverse output voltage and reverse voltages from output to input.

Current limit protection and thermal overload protection are intended to protect the device against current overload conditions at the output of the device. For normal operation the junction temperature must not exceed 125 °C.

The input of the device will withstand reverse voltages of 20 V. Current flowing into the device will be limited to less than 1 mA (typically less than 100  $\mu\text{A}$ ) and no negative voltage will appear at the output. The device will protect both itself and the load. This provides protection against batteries being plugged backwards.

The output of the TLS203B0EJV50 can be pulled below ground without damaging the device. If the input is left open-circuit or grounded, the output can be pulled below ground by 20 V. Under such conditions the output of the device by itself behaves like an open circuit with practically no current flowing out of the pin <sup>1)</sup>. In more application relevant cases however where the output is connected to the SENSE pin there will be a small current of typically less than 100  $\mu\text{A}$  present from this origin. If the input is powered by a voltage source the output will source the short circuit current of the device and will protect itself by thermal limiting. In this case grounding the EN pin will turn off the device and stop the output from sourcing the short-circuit current.

In circuits where a backup battery is required, several different input/output conditions can occur. The output voltage may be held up while the input is either pulled to ground, pulled to some intermediate voltage or is left open-circuit. Current flow back into the output will follow the curve as shown in **Figure 6** below.

1) typically < 1  $\mu\text{A}$  for the mentioned conditions,  $V_Q$  being pulled below ground with other pins either grounded or open.

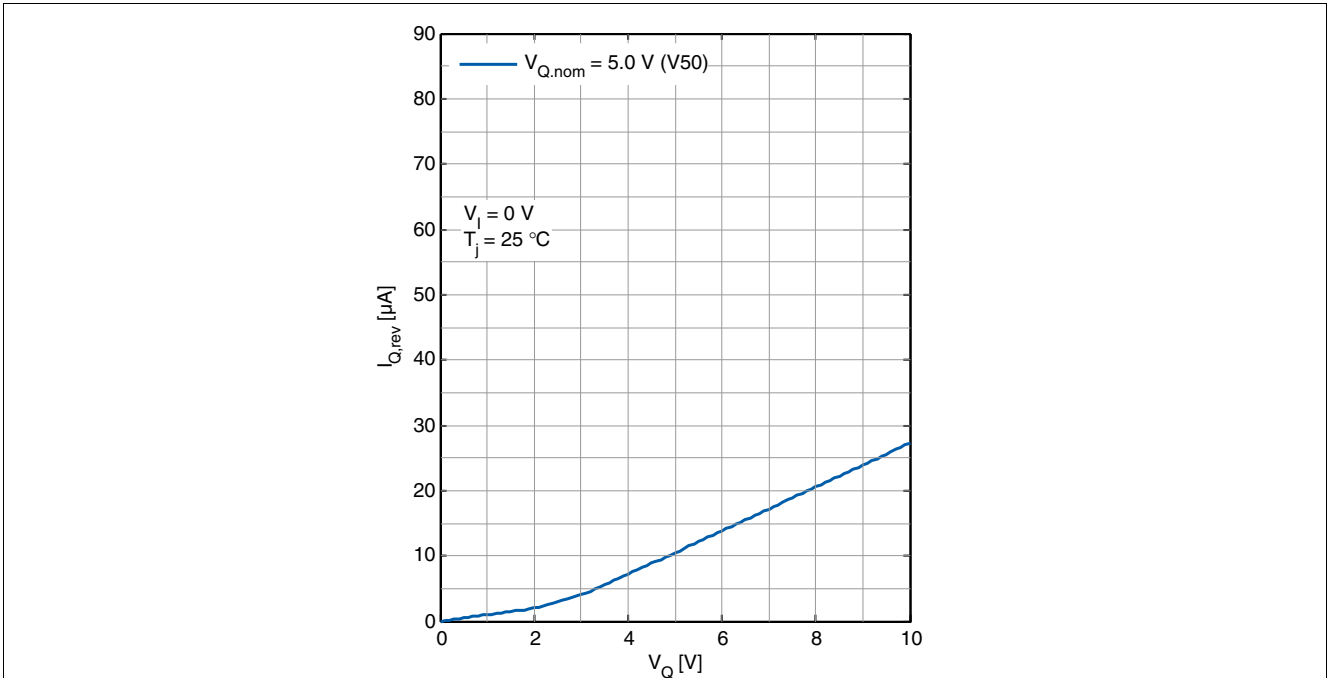


Figure 6 Reverse Output Current

## 7 Package Outlines

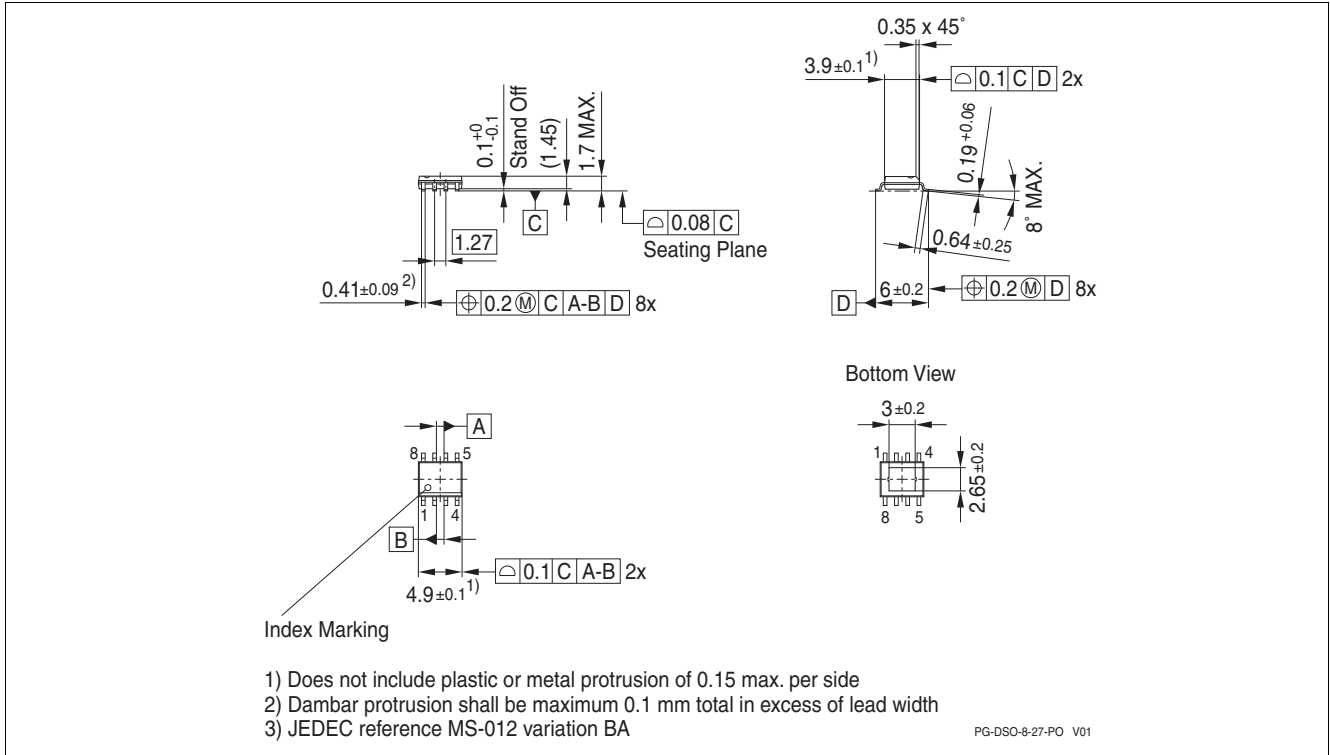


Figure 7 PG-DSO-8 Exposed Pad package outlines

### Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

## 8 Revision History

Revision	Date	Changes
1.0	2014-06-30	Data Sheet - Initial Release



**Edition 2014-06-30**

**Published by  
Infineon Technologies AG  
81726 Munich, Germany**

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